

## Features

- Split Gate Trench MOSFET Technology
- High Density Cell Design For Ultra Low  $R_{DS(on)}$
- Moisture Sensitivity Level 1
- Halogen Free."Green"Device<sup>(Note1)</sup>
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant<sup>(Note2)</sup>("P" Suffix Designates RoHS Compliant. See Ordering Information)

## N-CHANNEL MOSFET

## Maximum Ratings

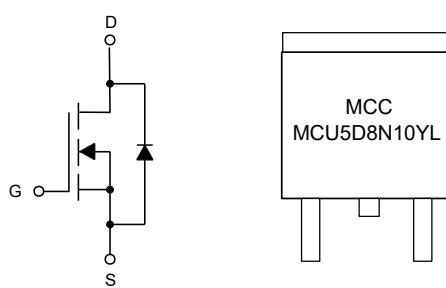
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 50°C/W Junction to Ambient<sup>(Note3)</sup>
- Thermal Resistance: 1.1°C/W Junction to Case

| Parameter  | Symbol   | Rating   | Unit |
|--|----------|----------|------|
| Drain-Source Voltage                             | $V_{DS}$ | 100      | V    |
| Gate-Source Voltage                              | $V_{GS}$ | $\pm 20$ | V    |
| Continuous Drain Current                         | $I_D$    | 100      | A    |
|  |          | 63       |      |
| Pulsed Drain Current <sup>(Note4)</sup>          | $I_{DM}$ | 400      | A    |
| Total Power Dissipation <sup>(Note5)</sup>       | $P_D$    | 113      | W    |
| Single Pulse Avalanche Energy <sup>(Note6)</sup> | $E_{AS}$ | 282      | mJ   |

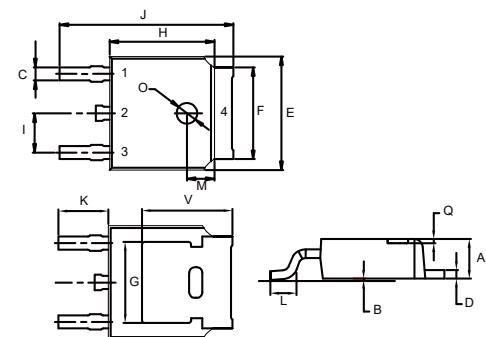
### Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. High Temperature Solder Exemption Applied, see EU Directive Annex 7a.
3. The value of  $R_{\theta_{JA}}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ .
4. Repetitive rating; pulse width limited by max. junction temperature.
5.  $P_D$  is based on max. junction temperature, using junction-case thermal resistance.
6.  $T_J=25^\circ C$ ,  $V_{DD}=50V$ ,  $V_{GS}=10V$ ,  $R_G=25\Omega$ ,  $L=0.5mH$ .

## Internal Structure and Marking Code



## DPAK(TO-252)



1. Gate  
2,4. Drain  
3. Source

| DIM | INCHES |       | MM   |       | NOTE |
|-----|--------|-------|------|-------|------|
|     | MIN    | MAX   | MIN  | MAX   |      |
| A   | 0.087  | 0.094 | 2.20 | 2.40  |      |
| B   | 0.000  | 0.005 | 0.00 | 0.13  |      |
| C   | 0.026  | 0.034 | 0.66 | 0.86  |      |
| D   | 0.018  | 0.023 | 0.46 | 0.58  |      |
| E   | 0.256  | 0.264 | 6.50 | 6.70  |      |
| F   | 0.201  | 0.215 | 5.10 | 5.46  |      |
| G   | 0.190  |       | 4.83 |       | TYP. |
| H   | 0.236  | 0.244 | 6.00 | 6.20  |      |
| I   | 0.086  | 0.094 | 2.18 | 2.39  |      |
| J   | 0.386  | 0.409 | 9.80 | 10.40 |      |
| K   | 0.114  |       | 2.90 |       | TYP. |
| L   | 0.055  | 0.067 | 1.40 | 1.70  |      |
| M   | 0.063  |       | 1.60 |       | TYP. |
| O   | 0.043  | 0.051 | 1.10 | 1.30  |      |
| Q   | 0.000  | 0.012 | 0.00 | 0.30  |      |
| V   | 0.211  |       | 5.35 |       | TYP. |

**Electrical Characteristics @ 25°C (Unless Otherwise Specified)**

| Parameter                       | Symbol        | Test Conditions                                   | Min | Typ  | Max       | Unit      |
|---------------------------------|---------------|---|-----|------|-----------|-----------|
| <b>Static Characteristics</b>   |               |   |     |      |           |           |
| Drain-Source Breakdown Voltage  | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=250\mu A$                         | 100 |      |           | V         |
| Gate-Source Leakage Current     | $I_{GSS}$     | $V_{DS}=0V, V_{GS}=\pm 20V$                       |     |      | $\pm 100$ | nA        |
| Zero Gate Voltage Drain Current | $I_{DSS}$     | $V_{DS}=100V, V_{GS}=0V$                          |     |      | 1         | $\mu A$   |
| Gate-Threshold Voltage          | $V_{GS(th)}$  | $V_{DS}=V_{GS}, I_D=250\mu A$                     | 1   | 1.7  | 2.5       | V         |
| Drain-Source On-Resistance      | $R_{DS(on)}$  | $V_{GS}=10V, I_D=50A$                             |     | 4.5  | 5.8       | $m\Omega$ |
|                                 |               | $V_{GS}=4.5V, I_D=25A$                            |     | 5.5  | 7.5       |           |
| Gate Resistance                 | $R_g$         | f=1 MHz, Open drain                               |     | 1.8  |           | $\Omega$  |
| <b>Diode Characteristics</b>    |               |   |     |      |           |           |
| Continuous Body Diode Current   | $I_S$         |   |     |      | 100       | A         |
| Diode Forward Voltage           | $V_{SD}$      | $V_{GS}=0V, I_S=50A$                              |     |      | 1.2       | V         |
| Reverse Recovery Time           | $t_{rr}$      | $I_F=50A, dI_F/dt=100A/\mu s$                     |     | 35.5 |           | ns        |
| Reverse Recovery Charge         | $Q_{rr}$      |   |     | 30   |           | nC        |
| <b>Dynamic Characteristics</b>  |               |   |     |      |           |           |
| Input Capacitance               | $C_{iss}$     | $V_{DS}=50V, V_{GS}=0V, f=1MHz$                   |     | 4010 |           | $pF$      |
| Output Capacitance              | $C_{oss}$     |   |     | 1300 |           |           |
| Reverse Transfer Capacitance    | $C_{rss}$     |   |     | 26   |           |           |
| Total Gate Charge               | $Q_g$         | $V_{DS}=50V, V_{GS}=10V, I_D=50A$                 |     | 60.6 |           | $nC$      |
| Gate-Source Charge              | $Q_{gs}$      |   |     | 12.6 |           |           |
| Gate-Drain Charge               | $Q_{gd}$      |   |     | 9.6  |           |           |
| Turn-On Delay Time              | $t_{d(on)}$   | $V_{DD}=50V, V_{GS}=10V, I_{DS}=50A, R_G=3\Omega$ |     | 18.5 |           | $ns$      |
| Turn-On Rise Time               | $t_r$         |   |     | 60.6 |           |           |
| Turn-Off Delay Time             | $t_{d(off)}$  |   |     | 50.7 |           |           |
| Turn-Off Fall Time              | $t_f$         |   |     | 19   |           |           |

## Curve Characteristics

Fig.1 - Typical Output Characteristics

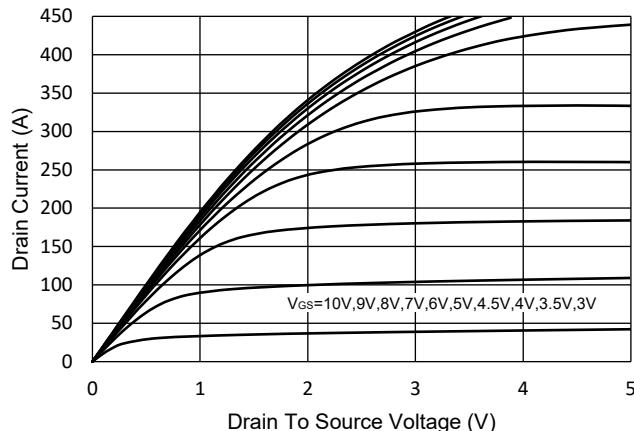


Fig.2 - Transfer Characteristics

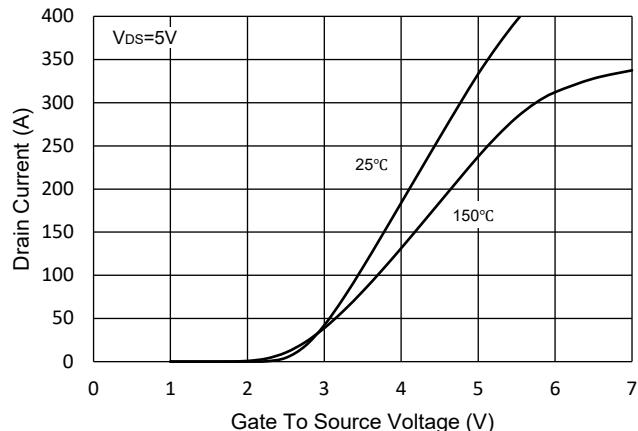


Fig.3 -  $R_{DS(ON)}$  -  $V_{GS}$

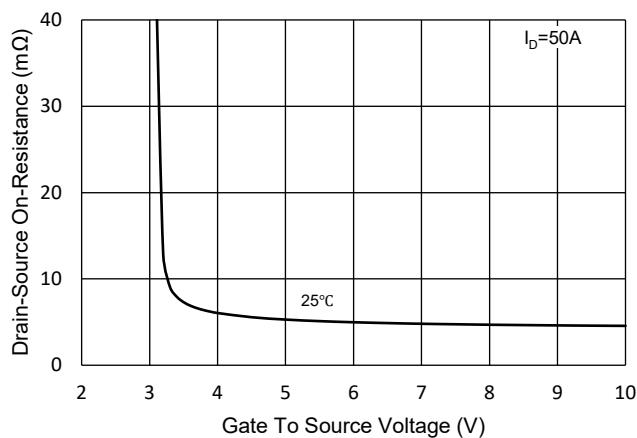


Fig.4 -  $R_{DS(ON)}$  -  $I_D$

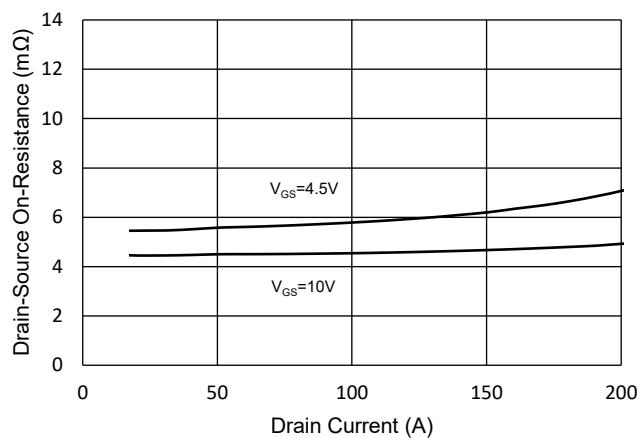


Fig.5 - Capacitance Characteristics

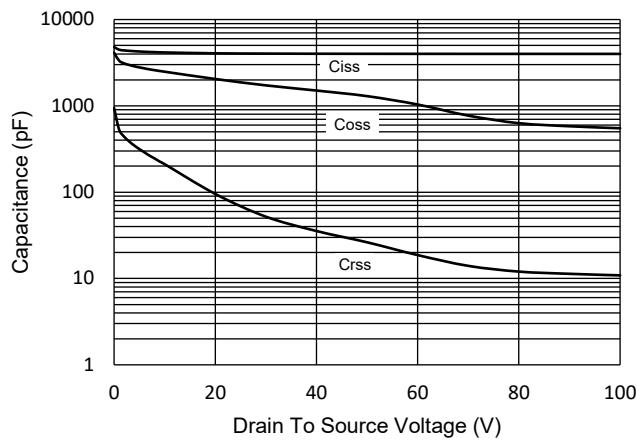
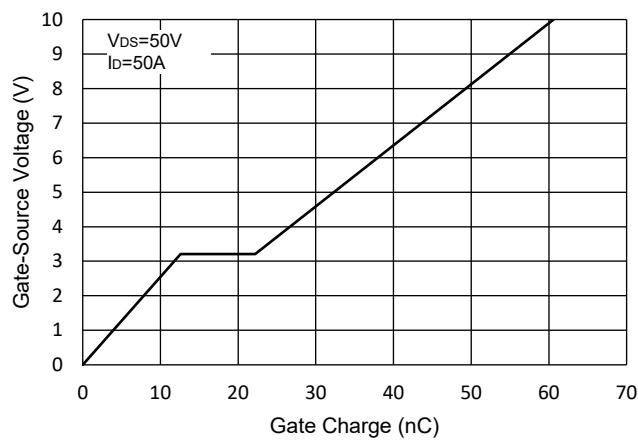


Fig.6 - Gate Charge



## Curve Characteristics

Fig.7 - Normalized Threshold Voltage

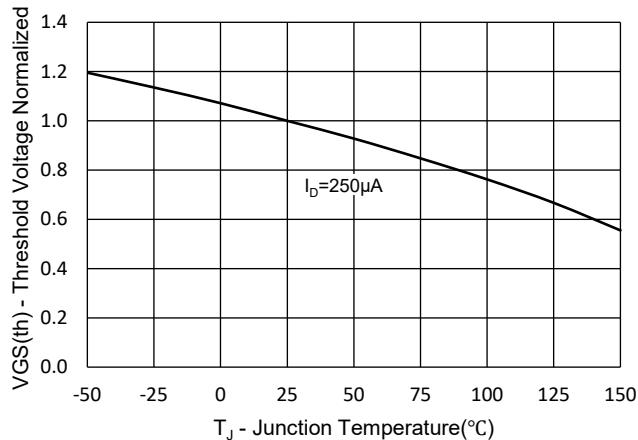


Fig.8 - Normalized On Resistance Characteristics

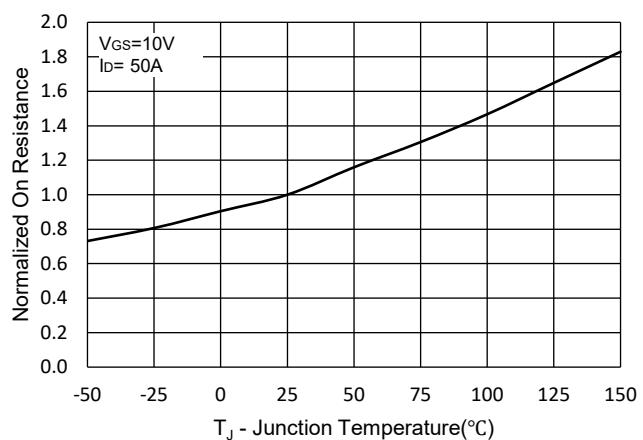


Fig.9 - I<sub>s</sub> - V<sub>SD</sub>

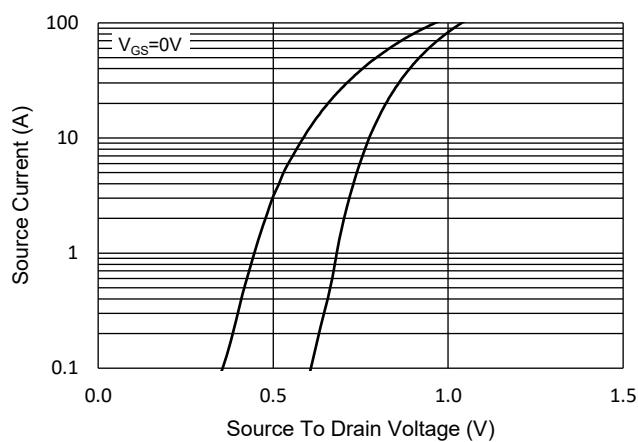


Fig.10 - Drain Current

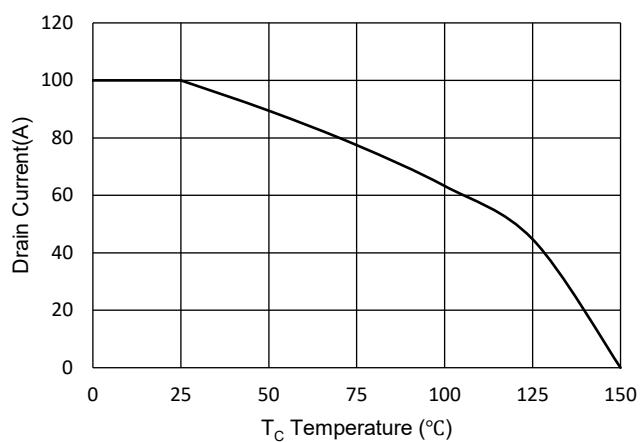
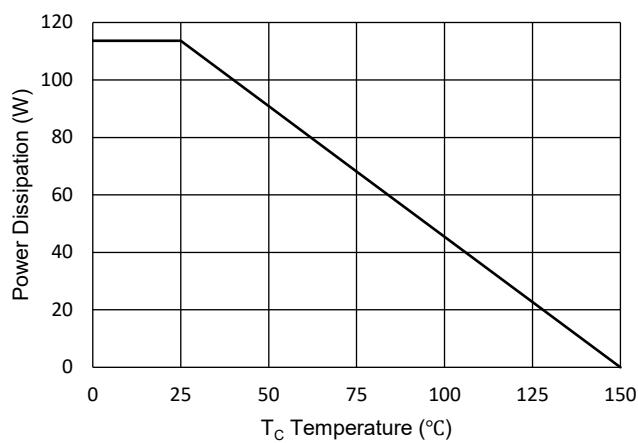


Fig.11 - PD Dissipation



## Curve Characteristics

Fig.12 - Safe Operation Area

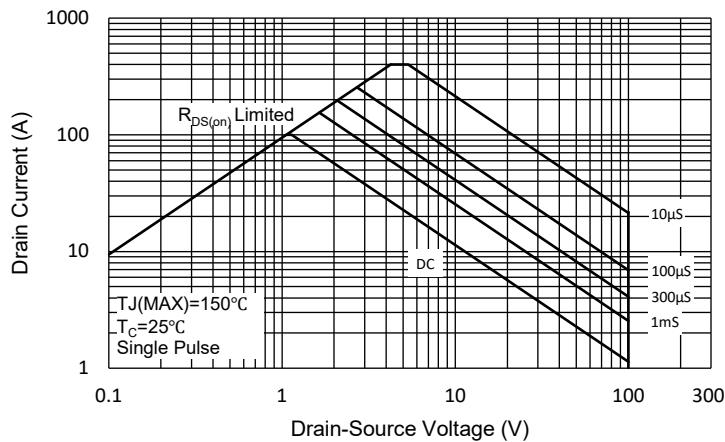
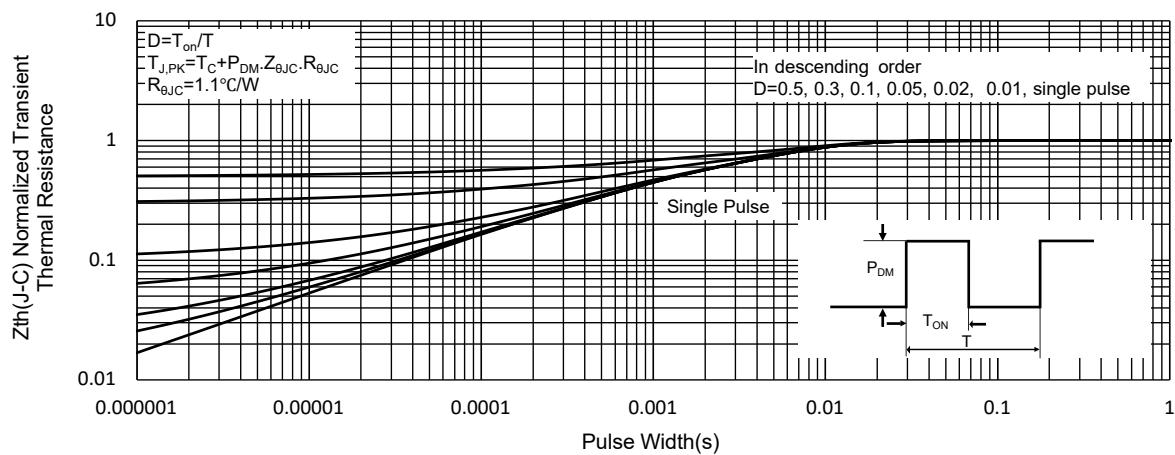


Fig.13 - Normalized Transient Thermal Impedance



## Ordering Information

| Device         | Packing                 |
|----------------|-------------------------|
| Part Number-TP | Tape&Reel: 2.5Kpcs/Reel |

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